New Jersey Semi-Conductor Products, Inc.

20 STERN AVE.
SPRINGFIELD, NEW JERSEY 07081
U.S.A.

TELEPHONE: (973) 376-2922
(212) 227-6005
FAX: (973) 376-8960

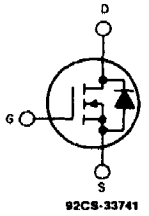
2N6763, 2N6764

N-Channel Enhancement-Mode Power MOS Field-Effect Transistors

31A and 38A, 60V-100V
$r_{DS}(on)$ = 0.08 Ω and 0.055 Ω

Features:
- *SOA is power-dissipation limited*
- *Nanosecond switching speeds*
- *Linear transfer characteristics*
- *High input impedance*
- *Majority carrier device*

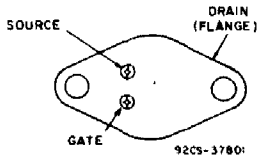
N-CHANNEL ENHANCEMENT MODE



TERMINAL DIAGRAM

The 2N6763 and 2N6764 are n-channel enhancement-mode silicon-gate power MOS field-effect transistors designed for applications such as switching regulators, switching converters, motor drivers, relay drivers, and drivers for high-power bipolar switching transistors requiring high speed and low gate-drive power. These types can be operated directly from integrated circuits.

TERMINAL DESIGNATION



MAXIMUM RATINGS, *Absolute-Maximum Values:*

	2N6763	2N6764	
* DRAIN-SOURCE VOLTAGE, V_{DS}	60	100	V
* DRAIN-GATE VOLTAGE, V_{DGR} (R_{GS} = 20 kΩ)	60	100	V
* GATE-SOURCE VOLTAGE, V_{GS}	±20		V
DRAIN CURRENT, I_D, RMS Continuous			
At T_C = 25°C	31	38	A
At T_C = 100°C	20	24	A
DRAIN CURRENT, I_{DM}, Pulsed	60	70	A
* POWER DISSIPATION, P_T			
At T_C = 25°C	150		W
At T_C = 100°C	60		W
Above T_C = 25°C, Derate Linearly	1.2		W/°C
INDUCTIVE CURRENT, I_{LM}, Clamped (L = 100 μH)	60	70	A
* OPERATING AND STORAGE TEMPERATURE, T_j, T_{stg}	-55 to +150		°C
* LEAD TEMPERATURE, T_L			
At distances 0.063 in. (1.6 mm) from seating plane for 10 s max.	300		°C

*JEDEC registered data.

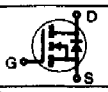
ELECTRICAL CHARACTERISTICS @ T_C = 25°C (Unless Otherwise Specified)

Parameter		Type	Min.	Typ.	Max.	Units	Test Conditions
BV_{DSS}	Drain – Source Breakdown Voltage	2N6763	60	–	–	V	V_{GS} = 0
		2N6764	100	–	–	V	I_D = 1.0 mA
$V_{GS(th)}$	Gate Threshold Voltage	ALL	2.0*	–	4.0*	V	V_{DS} = V_{GS}, I_D = 1 mA
I_{GSSF}	Gate – Body Leakage Forward	ALL	–	–	100*	nA	V_{GS} = 20V
I_{GSSR}	Gate – Body Leakage Reverse	ALL	–	–	100*	nA	V_{GS} = -20V
I_{DSS}	Zero Gate Voltage Drain Current	ALL	–	0.1	1.0*	mA	V_{DS} = Max. Rating, V_{GS} = 0
			–	0.2	4.0*	mA	V_{DS} = Max. Rating, V_{GS} = 0, T_C = 125°C
$V_{DS(on)}$	Static Drain-Source On-State Voltage ①	2N6763	–	–	2.48*	V	V_{GS} = 10V I_D = 31A
		2N6764	–	–	2.09*	V	V_{GS} = 10V, I_D = 38A
$R_{DS(on)}$	Static Drain-Source On-State Resistance ①	2N6763	–	0.06	0.08*	Ω	V_{GS} = 10V, I_D = 20A
		2N6764	–	0.045	0.055*	Ω	V_{GS} = 10V, I_D = 24A
$R_{DS(on)}$	Static Drain-Source On-State Resistance ①	2N6763	–	–	0.136*	Ω	V_{GS} = 10V, I_D = 20A, T_C = 125°C
		2N6764	–	–	0.094*	Ω	V_{GS} = 10V, I_D = 24A, T_C = 125°C
g_{fs}	Forward Transconductance ①	ALL	9.0*	12.5	27*	S (℧)	V_{DS} = 15V, I_D = 24A
C_{iss}	Input Capacitance	ALL	1000*	2000	3000*	pF	V_{GS} = 0, V_{DS} = 25V, f = 1.0 MHz See Fig. 10
C_{oss}	Output Capacitance	ALL	500*	1000	1500*	pF	
C_{rss}	Reverse Transfer Capacitance	ALL	150*	350	500*	pF	
$t_{d(on)}$	Turn-On Delay Time	ALL	–	–	35*	ns	$V_{DD} \cong$ 24V, I_D = 24A, Z_o = 4.7Ω (See Figs. 13 and 14) (MOSFET switching times are essentially independent of operating temperature.)
t_r	Rise Time	ALL	–	–	100*	ns	
$t_{d(off)}$	Turn-Off Delay Time	ALL	–	–	125*	ns	
t_f	Fall Time	ALL	–	–	100*	ns	

THERMAL RESISTANCE

R_{thJC}	Junction-to-Case	ALL	–	–	0.83*	°C/W	
R_{thCS}	Case-to-Sink	ALL	–	0.1	–	°C/W	Mounting surface flat, smooth, and greased.
R_{thJA}	Junction-to-Ambient	ALL	–	–	30	°C/W	Free Air Operation

BODY-DRAIN DIODE RATINGS AND CHARACTERISTICS

I_S	Continuous Source Current (Body Diode)	2N6763	–	–	31*	A	Modified MOSFET symbol showing the integral reverse P-N junction rectifier. 
		2N6764	–	–	38*		
I_{SM}	Pulsed Source Current (Body Diode)	2N6763	–	–	60	A	
		2N6764	–	–	70		
V_{SD}	Diode Forward Voltage ①	2N6763	0.90*	–	1.8*	V	T_C = 25°C, I_S = 31A, V_{GS} = 0
		2N6764	0.95*	–	1.9*	V	T_C = 25°C, I_S = 38A, V_{GS} = 0
t_{rr}	Reverse Recovery Time	ALL	–	500	–	ns	T_J = 150°C, I_F = I_{SM}, dI_F/dt = 100 A/μs
Q_{RR}	Reverse Recovered Charge	ALL	–	10	–	μC	T_J = 150°C, I_F = I_{SM}, dI_F/dt = 100 A/μs

*JEDEC registered values. ① Pulse Test: Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%